

Product Change Notification - SYST-09NKFA789

Date: 11 Feb 2016

Product Category: EQCOLogic

Affected CPNs:  

Notification subject: Data Sheet - EQCO30T5.2 Data Sheet Data Sheet Document Revision

Notification text: SYST-09NKFA789

Microchip has released a new DeviceDoc for the EQCO30T5.2 Data Sheet of devices. If you are using one of these devices please read the document located at [EQCO30T5.2 Data Sheet](#).

Notification Status: Final

Description of Change: 1) Removed electrostatic discharge ratings from Table 3-1. 2) Minor typographical changes.

Impacts to Data Sheet: None

Reason for Change: To Improve Productivity

Change Implementation Status: Complete

Date Document Changes Effective: 11 Feb 2016

NOTE: Please be advised that this is a change to the document only the product has not been changed.

Markings to Distinguish Revised from Unrevised Devices: N/A

Attachment(s):

[EQCO30T5.2 Data Sheet](#)

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Affected Catalog Part Numbers (CPN)

EQCO30T5.2-TRAY

EQCO30T5.2

EQCO30T5.2 3G/HD-SDI Video Cable Driver

Features

- Compatible with all SMPTE3G SDI Data Rates:
 - SMPTE259M SDI, 143 to 360 Mbps
 - SMPTE344M, 540 Mbps
 - SMPTE292M HD-SDI, 1.485 Gbps
 - SMPTE372M Dual-Link HD-SDI, 2.97 Gbps
 - SMPTE424M Dual-Speed 3G-SDI, 2.97 Gbps
- Pin Compatible with Gennum and National Semiconductor Parts
- Loss of Signal Detect at Input, Optional 3 dB Input Trace/Receive Equalization
- Also Operates with 8B/10B Coding
- Single 3.3V Supply.
- Low Power Consumption (150 mW, 3.3V supply)
- Output Driver Enable
- LF-Uplink Receiver Included, Receiving 5 Mbps in Full-Duplex Communication for Cable Lengths in 0-450m Range
- Up to 900 mA can be Received for Powering Camera Devices
- Selectable Slew Rate for SD and HD/3G
- 16-Pin, 0.65 mm Pin Pitch, 4 mm QFN Package
- -40°C to +85°C Industrial Temperature Range
- Pb-Free and RoHS Compliant

Applications

- High Definition, High Frame Rate Pro-Video HD-SDI Frame Store
- Surveillance, Industrial/Inspection, Medical Video Inputs
- HDcctv Applications

Note: The EQCO30T5 cable driver can be used in combination with the EQCO30R5 video equalizer. This device is capable of transmitting the uplink signal whilst other key parameters remain compliant to SMPTE specifications. Please refer to the Microchip web site (www.microchip.com) for the EQCO30R5 data sheet.

Introduction

The EQCO30T5 is a video cable driver for 3G/HD/SDI video, with speeds up to 4.0 Gbps. It is designed to be a direct replacement for competing cable drivers. In addition to downlink functionality from camera to frame grabber, it can also receive a 5 Mbps uplink signal from the frame grabber to the camera. Additionally, power can be provided over the same cable using the same chip and a few external components. The device operates with 8B/10B coded signals and with SMPTE signals up to 2.97 Gbps.

EQCO30T5.2

Typical Link Performance

Table 1, Table 2 and Table 3 give an overview of link performance (EQCO30T5 and EQCO30R5 combined) at room temperature without using the uplink and without providing power over the same coax. When providing power or using the uplink communication to the camera, a small length penalty may arise (in cable length, typically 10%) due to added parasitics and noise. The uplink operates to at least 400m at the 5 Mbps bit rate.

TABLE 1: BELDEN TYPICAL LINK PERFORMANCE

| | Name | Belden 7731A | Belden 1694A | Belden 1505A | Belden 1505F | Belden 1855A |
|------------|------|---------------|-------------------|-----------------|--------------|----------------|
| | Type | Long Distance | Industry Standard | Compromise Coax | Flexible | Thinnest Cable |
| Diameter | (mm) | 10.3 | 6.99 | 5.94 | 6.15 | 4.03 |
| 270 Mbps | (m) | 718 | 469 | 384 | 302 | 270 |
| 1.485 Gbps | (m) | 332 | 223 | 187 | 136 | 132 |
| 2.97 Gbps | (m) | 219 | 149 | 128 | 89 | 91 |

TABLE 2: GEPKO TYPICAL LINK PERFORMANCE

| | Name | Gepco VHD1100 | Gepco VSD2001 | Gepco VPM2000 | Gepco VHD2000M | Gepco VDM230 |
|------------|------|---------------|-------------------|-----------------|----------------|----------------|
| | Type | Long Distance | Industry Standard | Compromise Coax | Flexible | Thinnest Cable |
| Diameter | (mm) | 10.3 | 6.91 | 6.15 | 6.15 | 4.16 |
| 270 Mbps | (m) | 772 | 502 | 387 | 305 | 273 |
| 1.485 Gbps | (m) | 372 | 241 | 187 | 138 | 133 |
| 2.97 Gbps | (m) | 252 | 163 | 128 | 91 | 92 |

TABLE 3: CANARE TYPICAL LINK PERFORMANCE

| | Name | Canare L-7CFB | Canare L-5CFB | Canare L-4CFB | Canare L-3CFB | Canare L-2.5CFB |
|------------|------|---------------|-------------------|-----------------|---------------|-----------------|
| | Type | Long Distance | Industry Standard | Compromise Coax | Thin Cable | Thinnest Cable |
| Diameter | (mm) | 10.3 | 6.99 | 5.94 | 6.15 | 4.03 |
| 270 Mbps | (m) | 615 | 434 | 344 | 287 | 223 |
| 1.485 Gbps | (m) | 281 | 201 | 161 | 135 | 109 |
| 2.97 Gbps | (m) | 182 | 132 | 107 | 90 | 73 |

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EQCO30T5.2

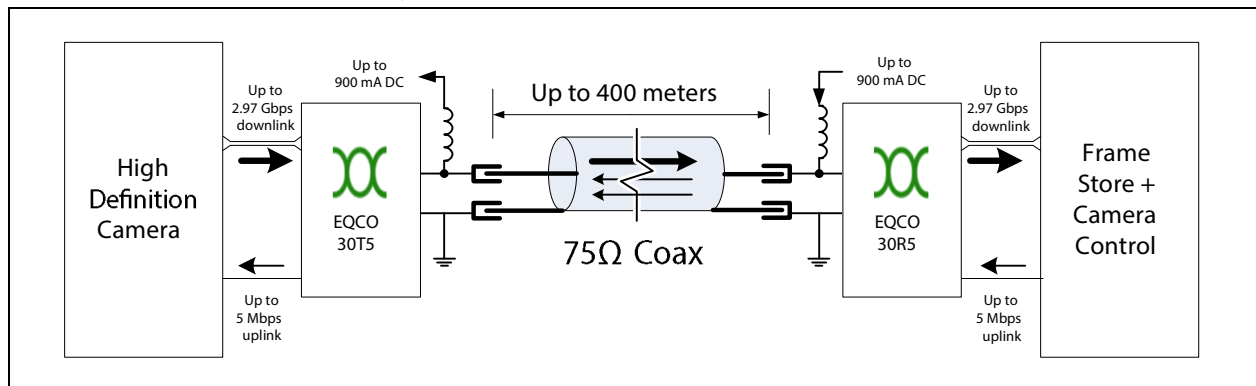
1.0 DEVICE OVERVIEW

The EQCO30T5 is a dual slew rate cable driver designed to drive digital signals over coaxial cable. The EQCO30T5 chip is optimized for driving SMPTE HD-SDI signals, but works equally well with 8B/10B coded signals.

The EQCO30R5 is a video equalizer that matches to the EQCO30T5, since it can transmit the uplink signal. Implementing the uplink requires very few additional components on both sides of the link, and complies with SMPTE specifications. The EQCO30R5 data sheet is available separately from Microchip.

Figure 1-1 shows a typical communication link using the EQCO30T5 and EQCO30R5 chips:

FIGURE 1-1: TYPICAL EQCO30T5 SETUP



The EQCO30T5 includes an uplink receiver for receiving digital data coming from the frame store in full-duplex, giving 5 Mbps of bandwidth for:

- Triggering purposes, Auxiliary outputs
- Firmware upgrades,
- Audio channels
- Etc.

1.1 Pinout and Pin Description

FIGURE 1-2: EQCO30T5.2 PIN DIAGRAM (VIEWED FROM TOP)

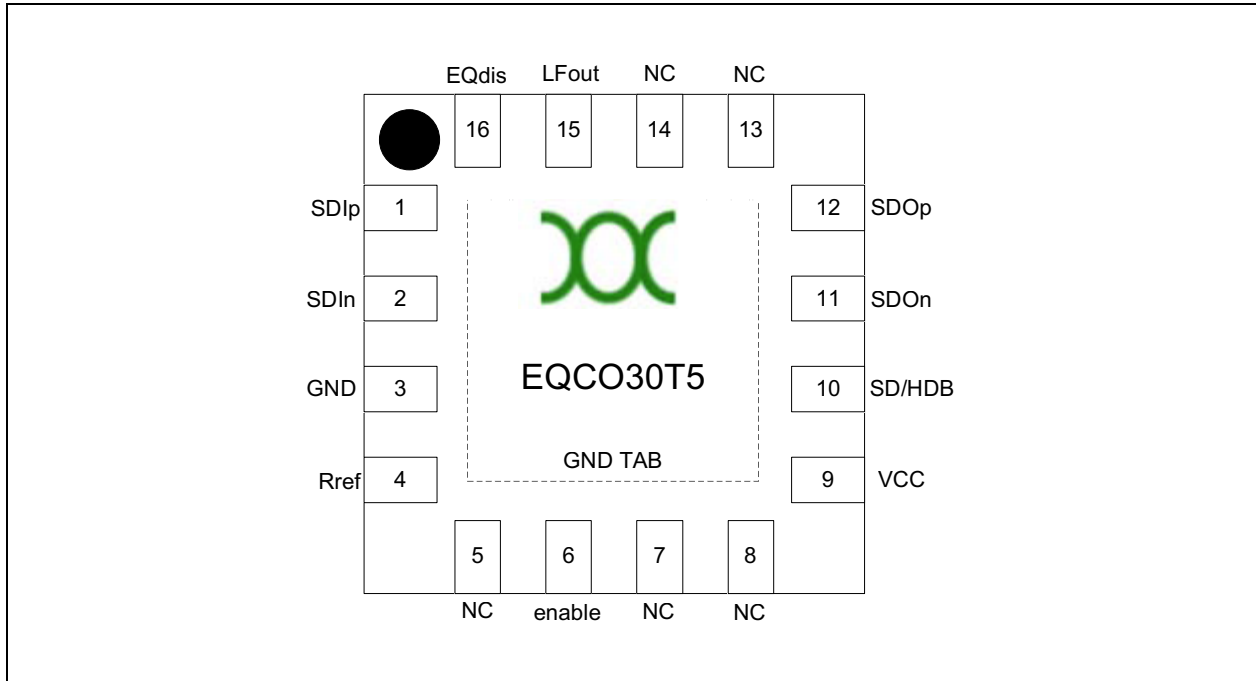


TABLE 1-1: EQCO30T5.2 PIN DESCRIPTIONS

| Pin Number | Pin Name | Signal Type | Description |
|-----------------|------------------|--------------------|--|
| (TAB) | GND | Power | Use as single-point ground. |
| 1, 2 | SDIp, SDIn | Differential Input | Serial input positive/negative differential serial input. |
| 3 | GND | Power | Ground. Connect to GND TAB. |
| 4 | R _{ref} | Analog Input | Input determining output amplitude of cable driver. |
| 9 | VCC | Power | +3.3V of power supply. |
| 6 | Enable | Input | Enables the output driver pins. |
| 5, 7, 8, 13, 14 | NC | Input | Do not connect; leave floating. Used for internal testing. |
| 10 | SD/HDB | Input | Select edge rate. |
| 11 | SDOn | Driver Output | Serial negative cable driver output with 50Ω on-chip serial output resistance. Complement with 25Ω externally. |
| 12 | SDOp | Driver Output | Serial positive cable driver output with 50Ω on-chip serial output resistance. Complement with 25Ω externally. |
| 15 | LFout | Output | Digital output signal of the full-duplex uplink. |
| 16 | EQdis | Input | Disables input trace equalization. |

1.1.1 SDIP/SDIN

SDIp/SDIn together form a differential input pair. Between SDIp and SDIn inputs, there is a termination resistor of 100Ω. The intention is to always use AC coupling. When AC-coupled, the common-mode gets biased to 600 mV.

1.1.2 RREF

A resistor is to be connected between VCC and the R_{ref} pin. A resistor of 750Ω gives an 800 mV launch amplitude in the 75Ω coaxial cables. A larger resistor gives a smaller amplitude.

1.1.3 ENABLE

When enable is floating or pulled high, the output driver is enabled. When enable is low, the output is disabled and power consumption drops significantly.

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1.1.4 SD/HDB

With SD/HDB set to high, the output rise and fall times are set for SD operation. When left floating or pulled low, the rise and fall times are set for 3G/HD operation.

1.1.5 SDO_n, SDO_p

The output driver is not based on a CML output stage. Both outputs operate independently, so there is very little interference between the outputs and their termination condition. There is also no LR-output network needed for achieving good return-loss. A 25Ω resistor should be connected in series with the output to drive a 75Ω coax cable. The output amplitude is achieved behind this 25Ω resistor; refer to the application circuits at the end of the data sheet. The PCB doesn't require layout changes when migrating from competing cable drivers, however, fewer components are needed. One does not need to optimize the return-loss network, since it is omitted.

1.1.6 LFOUT

LFout provides the 5 Mbps received uplink signal (LVTTTL voltage levels). It can easily drive a PCB trace of 20 pF at this speed. For longer distance communication from this pin to the next chip, using a buffer is recommended. The output impedance is about 300Ω.

1.1.7 EQ_{dis}

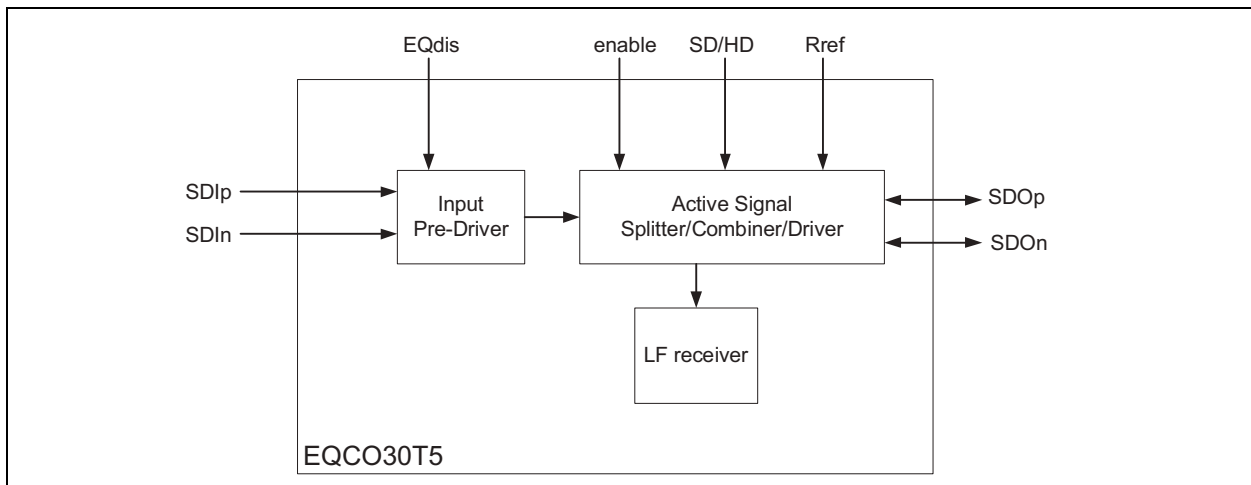
When EQ_{dis} is left floating or pulled low, the input trace equalization is turned on and invokes a typical 3 dB gain at 1.5 GHz.

This value is optimized for compensating the high-frequency losses of approximately 20 cm of 5-mil stripline in FR4. When pulled high, this equalization is turned off.

1.2 Circuit Operation

Figure 1-3 is a block diagram of the EQCO30T5, showing electrical connections. The input pre-driver brings the input signal to a digital signal, with or without the use of input trace equalization. The active splitter/combiner/driver launches the digital signal in the cable, with an amplitude determined by the external resistor connected to R_{ref} and with an edge rate for SD or 3G/HD-SDI depending on the SD/HDB signal. It also splits the incoming signal towards the LF receiver to provide the 5 Mbps LF_{out} signal.

FIGURE 1-3: EQCO30T5 BLOCK DIAGRAM SHOWING ELECTRICAL CONNECTIONS



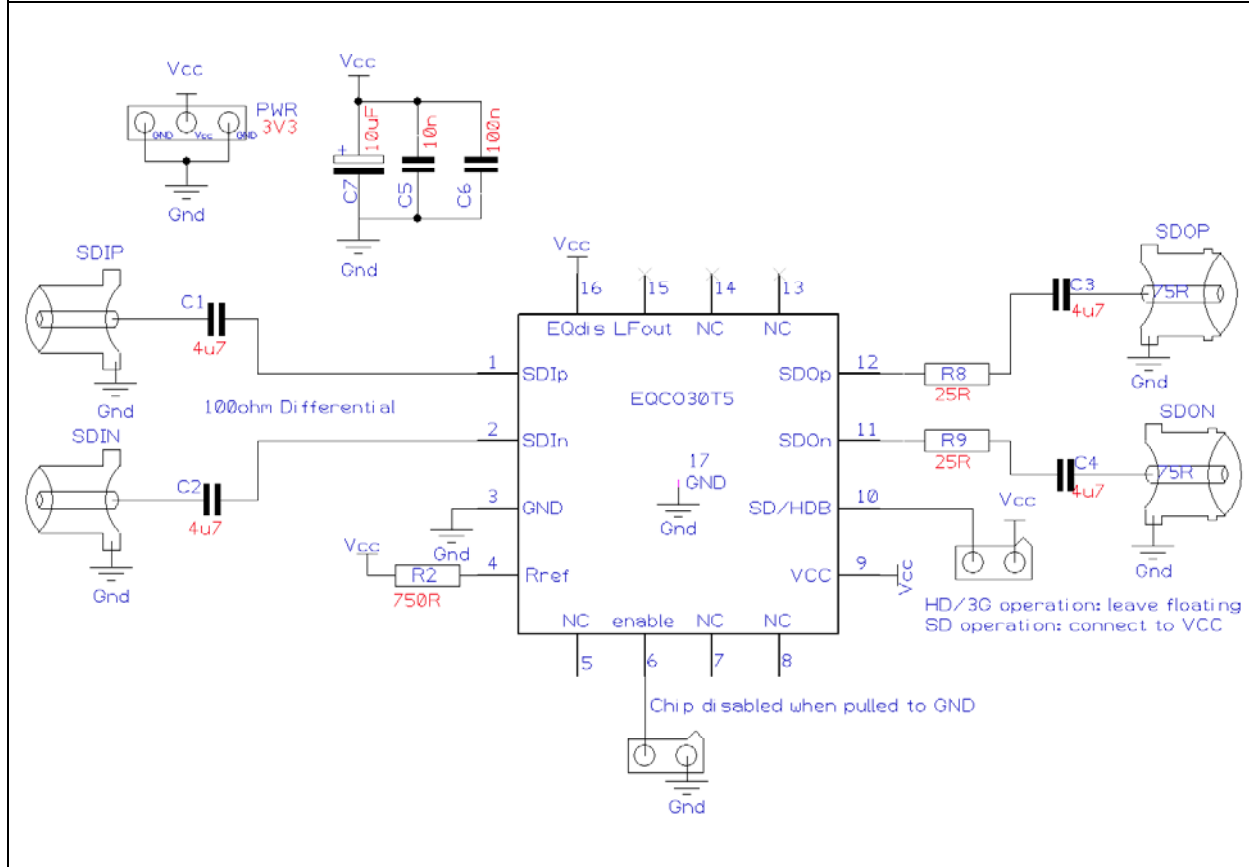
EQCO30T5.2

2.0 APPLICATION INFORMATION

2.1 Typical Application Circuit as SMPTE Cable Driver

Figure 2-1 illustrates a typical schematic implementation of the EQCO30T5 used as a cable driver for SMPTE video signals.

FIGURE 2-1: EQCO30T5.2 TYPICAL APPLICATION CIRCUIT AS SMPTE CABLE DRIVER



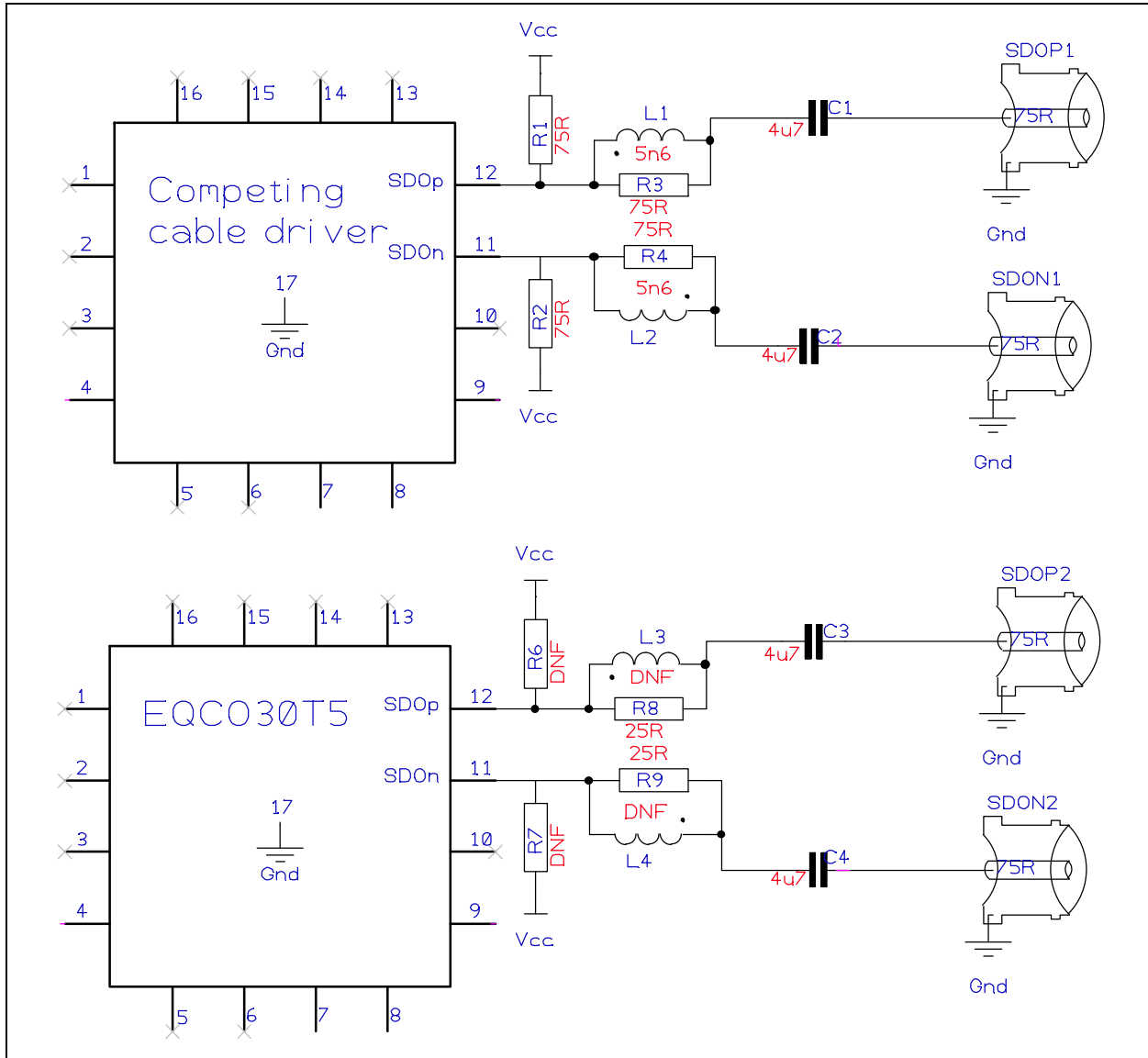
Resistors R8 and R9 are to be placed close to pins 12 and 11, respectively. From there onwards, the traces up to the coax connectors should be laid-out as 75Ω traces (including the C3 and C4 capacitors as AC-couplers).

2.1.1 RETURN-LOSS NETWORK

Competing cable drivers need external RL return-loss networks. The EQCO30T5 does not need these type of external networks. Figure 2-2 compares the output network of the EQCO30T5 with the network of competing cable drivers.

The EQCO30T5 is pin-compatible with other cable drivers, but with a different component population. No termination resistor to VCC is required (do not fit = DNF). The inductor of the return loss network must not be populated and the 75Ω resistor of this network should be replaced with a 25Ω resistor to achieve correct operation.

FIGURE 2-2: COMPARISON BETWEEN EQCO30T5 AND COMPETING SOLUTIONS

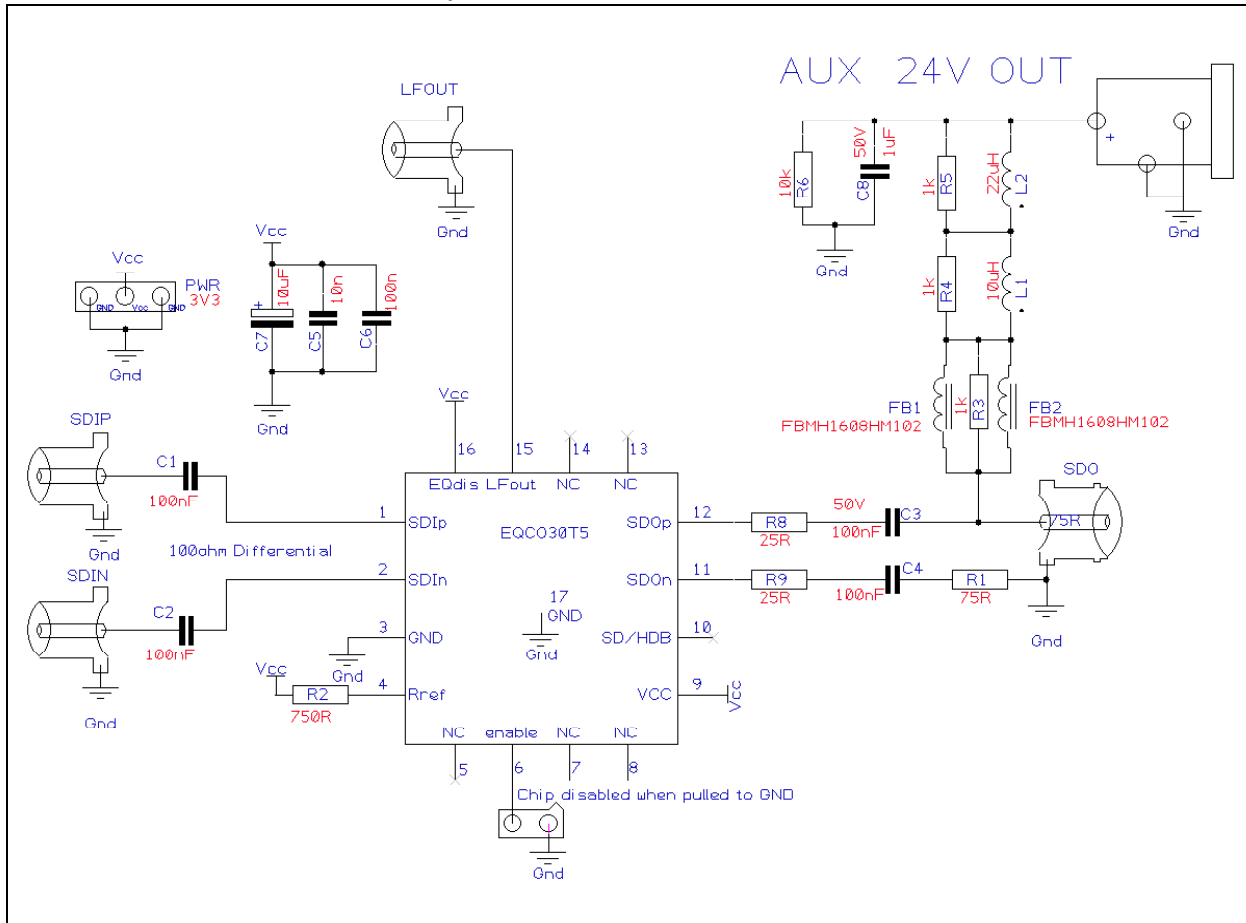


Note: Resistors marked DNF indicate "Do Not Fit"

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2.2 EQCO30T5 in Bidirectional Link (Including Power Supply)

FIGURE 2-3: EQCO30T5 IN BIDIRECTIONAL LINK (INCLUDING POWER SUPPLY TRANSMISSION)



Resistors R8 and R9 are to be placed close to pins 12 and 11, respectively. From there onwards, the traces up to the coax connector SDIP1 should be laid out as 75Ω traces (including the C3 and C4 capacitors as AC couplers). Resistor R1 has to be placed very close to this coax connector with a very short, low-impedance connection between one of the shielding pins of the connector and the resistor. To achieve the return-loss illustrated in the appendix, the power and ground planes below components FB1, FB2, R3, R4, L1, R5, L2 should be removed (applying cut-outs).

2.2.1 COMPONENT RECOMMENDATION

When using the components below, a maximum current of 900 mA can be communicated to power-up the camera side. Different types of inductors may be suitable in order to allow a higher current level, however, the RF quality of the inductor should be checked.

Ferrite Beads Fb1, Fb2 = FBMH1608HM102 from Taiyo Yuden

Inductor L1= 1812PS_103 from Coilcraft

3.0 ELECTRICAL CHARACTERISTICS

3.1 Absolute Maximum Ratings

Stresses beyond those listed under this section may cause permanent damage to the device. These are stress ratings only and are not tested. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TABLE 3-1: ABSOLUTE MAXIMUM RATINGS

| Parameter | Conditions | Min. | Typ. | Max. | Units |
|--------------------------|--------------------------------------|------|------|------|-------|
| Storage Temperature | — | -65 | — | +150 | °C |
| Ambient Temperature | Power applied | -55 | — | +125 | °C |
| Operating Temperature | Normal operation (VCC = 1.2V ±5%) | -40 | — | +85 | °C |
| Supply Voltage to Ground | — | -0.8 | — | +3.6 | V |
| DC Input Voltage | — | -0.8 | — | +3.6 | V |
| DC Voltage to Outputs | — | -0.8 | — | +3.6 | V |
| Current into Outputs | Outputs low | — | — | 90 | mA |

TABLE 3-2: ELECTRICAL CHARACTERISTICS (OVER THE OPERATING VCC AND -40 TO +85°C RANGE)

| Parameter | Description | Min. | Typ. | Max. | Unit |
|-----------------------------|---|-------|------|-------|------|
| Power Supply | | | | | |
| VCC | Supply voltage | 3.15 | 3.3 | 3.45 | V |
| I _s | Supply current, both transmitting and receiving | — | 45 | — | mA |
| Operational Bit Rate | | | | | |
| BR _{output} | Bit rate cable driver output | 0.05 | — | 4 | Gbps |
| BR _{uplink} | Bit rate uplink receiver | 0.5 | — | 5 | Mbps |
| SDIp/SDIn Input | | | | | |
| ΔVi | Input amplitude V _{SDIp,n} | 2x100 | — | 2x900 | mV |
| V _{CMIN} | Input common-mode voltage | — | 600 | — | mV |
| R _{input} | Differential input termination | — | 2x50 | — | Ω |

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TABLE 3-2: ELECTRICAL CHARACTERISTICS (OVER THE OPERATING VCC AND -40 TO +85°C RANGE) (CONTINUED)

| SDOp connection to Coax | | | | | |
|------------------------------------|--|-----|-----|-----|----------|
| Z_{coax} | Coax cable characteristic impedance | — | 75 | — | Ω |
| $R_{\text{SDOp}}, R_{\text{SDOn}}$ | Input impedance between SDOp and VCC/GND. To get to 75, add external 25 Ω series resistor. | 45 | 50 | 55 | Ω |
| R_{loss} | Return-Loss as seen on SDOp pin having 25 Ω series resistor. Frequency range = 5 MHz-1.5 GHz | — | — | -15 | dB |
| R_{loss} | Return-Loss as seen on SDOp pin having 25 Ω series resistor. Frequency range = 1.5 GHz-3.0 GHz | — | — | -10 | dB |
| ΔV_{TX} | Transmit amplitude with $R_{\text{ref}} = 750\Omega$ | 720 | 800 | 880 | mV |
| $t_{\text{rise_tx_SD}}$ | Rise/Fall time 20% to 80% of ΔV_{TX} (SD/HDB = High) | 400 | — | 800 | ps |
| $t_{\text{rise_tx}}$ | Rise/Fall time 20% to 80% of ΔV_{TX} (SD/HDB = Low) | — | — | 65 | ps |
| LFO Output (LVTTTL-like) | | | | | |
| $t_{\text{rise_ILFO}}$ | Rise/Fall time 20% to 80% of V_{CC} for 20 pF load | — | 15 | — | ns |

TABLE 3-3: JITTER NUMBERS⁽¹⁾

| Parameter | Conditions | Min. | Typ. | Max. | Units |
|---|---|------|------|------|-------|
| Additive peak to peak jitter on SDOp and SDOn | Downlink signal = 3.0 Gbps | — | 10 | — | ps |
| Peak to peak jitter on LFO | 0-450m ⁽²⁾ , @ low-speed signal = 5 Mbps, 8B/10B, and @ downlink signal = 270 Mbps, 8B/10B | — | 50 | — | ns |

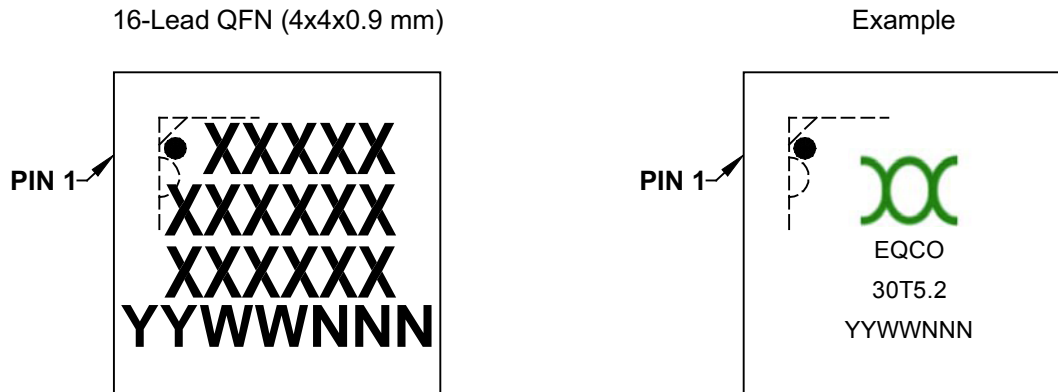
1: Jitter numbers (over operating VCC range at -40°C to +85°C and full ΔV_{TX} range with pathological patterns)

2: Measured with Belden 1694A coaxial cable

4.0 PACKAGING INFORMATION

4.1 Package Marking Information

16-Lead Plastic Quad Flat, No Lead Package – 4x4x0.9 mm Body [QFN]



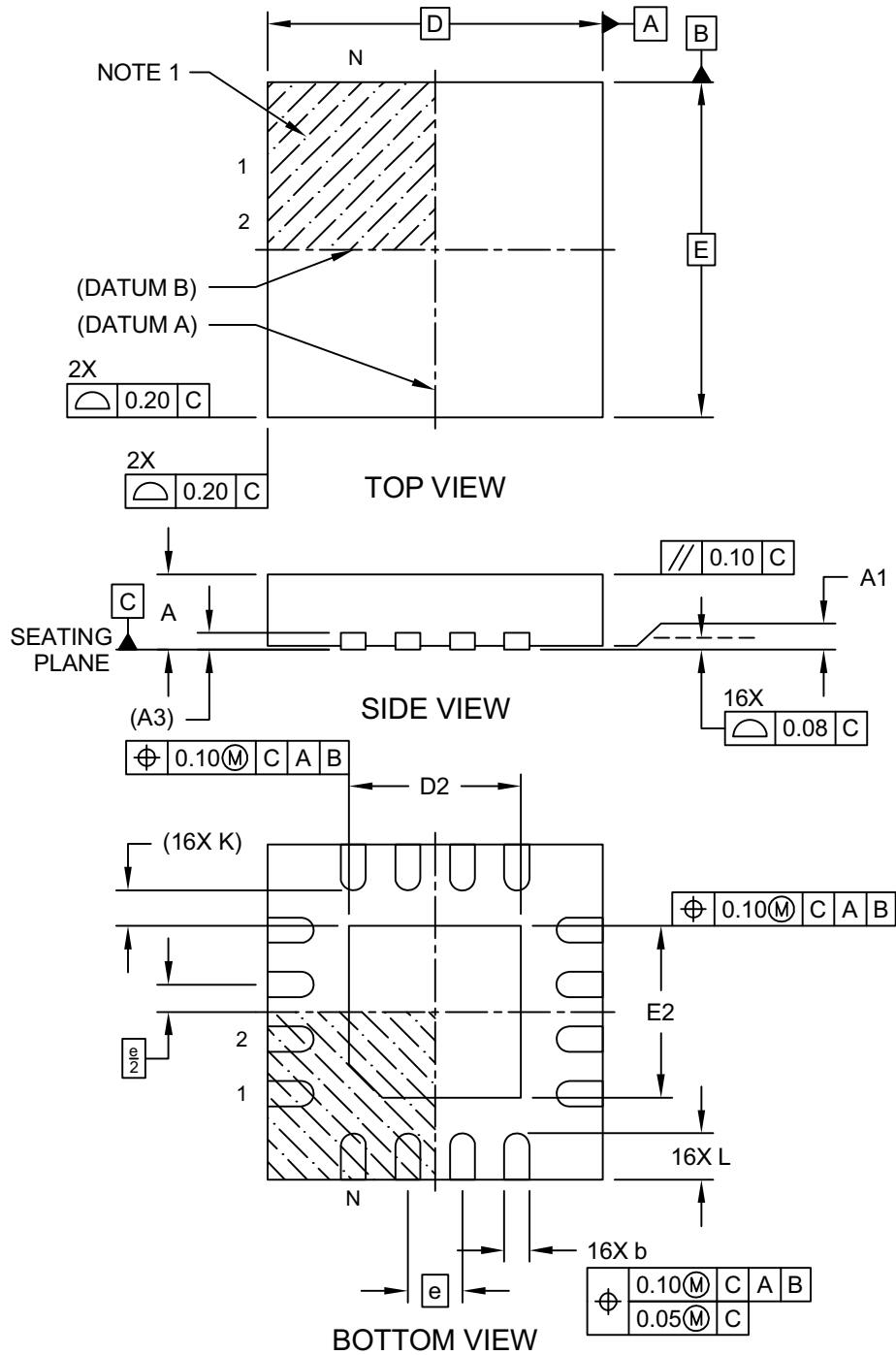
| | | |
|----------------|--------|--|
| Legend: | XX...X | Customer-specific information |
| | Y | Year code (last digit of calendar year) |
| | YY | Year code (last 2 digits of calendar year) |
| | WW | Week code (week of January 1 is week '01') |
| | NNN | Alphanumeric traceability code |
| | (e3) | Pb-free JEDEC® designator for Matte Tin (Sn) |
| | * | This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package. |

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

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16-Lead Plastic Quad Flat, No Lead Package (8E) - 4x4x0.9 mm Body [QFN]

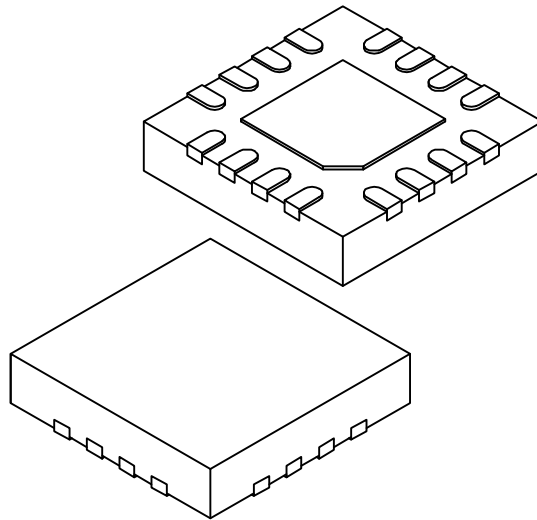
Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing C04-259B Sheet 1 of 2

16-Lead Plastic Quad Flat, No Lead Package (8E) - 4x4x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| | | Units | MILLIMETERS | | |
|-------------------------|----|-------|-------------|------|-----|
| Dimension Limits | | | MIN | NOM | MAX |
| Number of Pins | N | | 16 | | |
| Pitch | e | | 0.65 BSC | | |
| Overall Height | A | 0.80 | 0.87 | 0.95 | |
| Standoff | A1 | 0.00 | 0.02 | 0.05 | |
| Terminal Thickness | A3 | | 0.20 REF | | |
| Overall Width | E | | 4.00 BSC | | |
| Exposed Pad Width | E2 | 1.95 | 2.05 | 2.15 | |
| Overall Length | D | | 4.00 BSC | | |
| Exposed Pad Length | D2 | 1.95 | 2.05 | 2.15 | |
| Terminal Width | b | 0.25 | 0.30 | 0.35 | |
| Terminal Length | L | 0.45 | 0.55 | 0.65 | |
| Terminal-to-Exposed-Pad | K | | 0.425 REF | | |

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

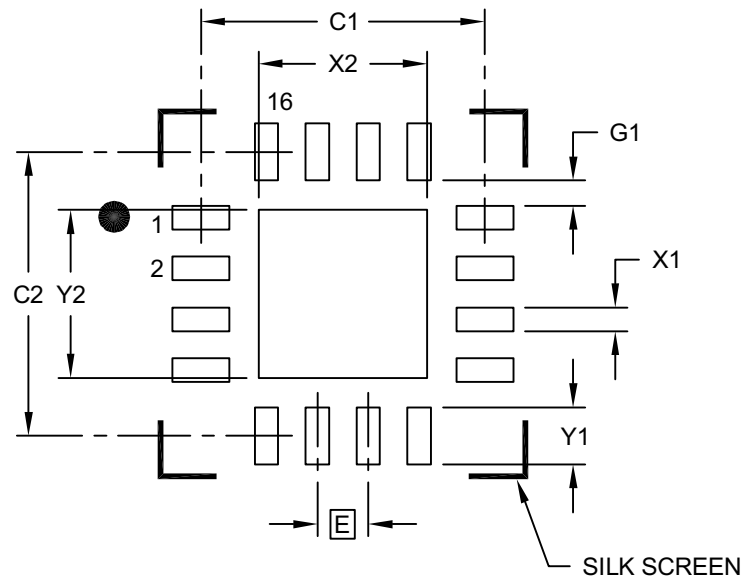
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-259B Sheet 2 of 2

EQCO30T5.2

16-Lead Plastic Quad Flat, No Lead Package (8E) - 4x4x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packageing>



RECOMMENDED LAND PATTERN

| Dimension Limits | Units | MILLIMETERS | | |
|---------------------------------|-------|-------------|-------|-------|
| | | MIN | NOM | MAX |
| Contact Pitch | E | 0.65 BSC | | |
| Optional Center Pad Width | X2 | | | 2.15 |
| Optional Center Pad Length | Y2 | | | 2.15 |
| Contact Pad Spacing | C1 | | 3.625 | |
| Contact Pad Spacing | C2 | | 3.625 | |
| Contact Pad Width (X16) | X1 | | | 0.30 |
| Contact Pad Length (X16) | Y1 | | | 0.725 |
| Contact Pad to Center Pad (X16) | G1 | 0.20 | | |

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-2259A

APPENDIX A: REVISION HISTORY

Revision C (February 2016)

- Removed electrostatic discharge ratings from [Table 3-1](#).
- Minor typographical changes.

Revision B (February 2015)

- Updated the typical application circuit diagrams in [Figures 2-1](#) and [2-3](#).

Revision A (September 2014)

This is the initial release of the document in the Microchip format. This replaces EqcoLogic document version 2v0.

TABLE A-1: VERSION HISTORY

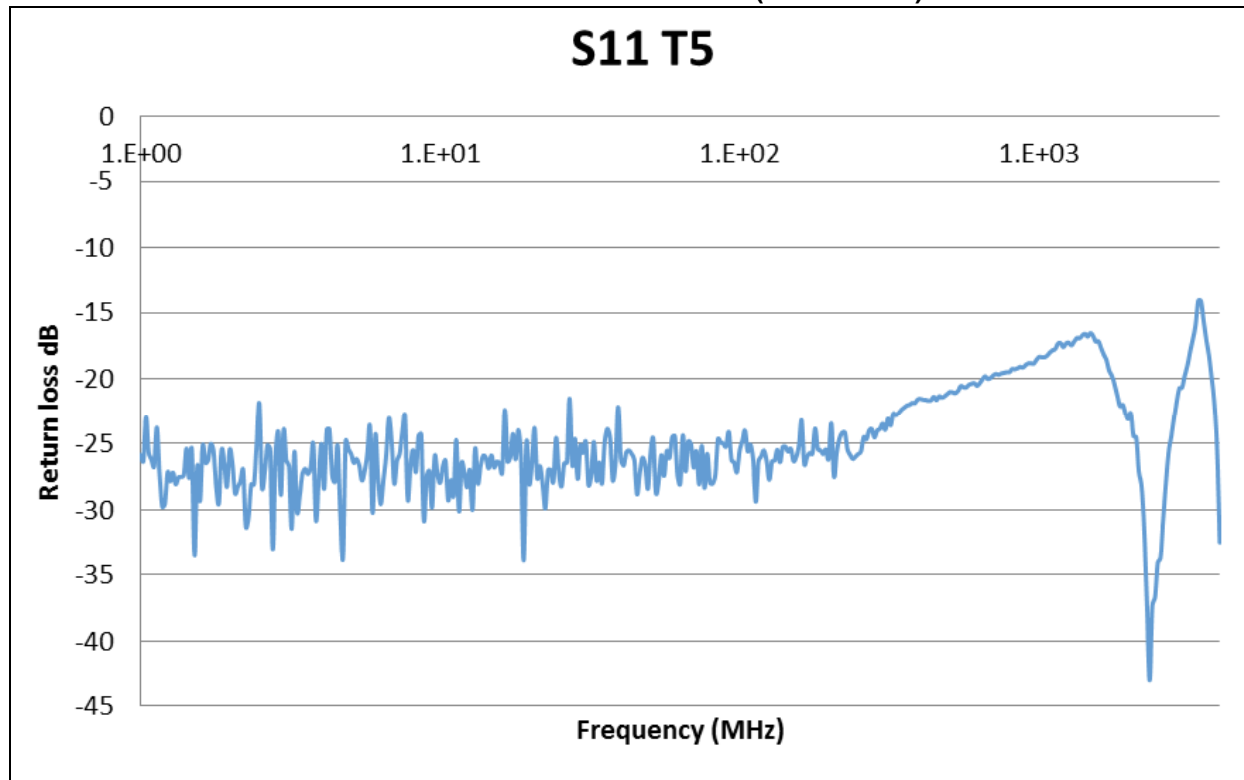
| Version | Date | Author | Comments |
|---------|---------|------------|-------------------------------|
| 2v0 | 1/27/14 | A. Peeters | Revision |
| 1v0 | 3/13/12 | A. Peeters | Final document |
| 0v2 | 1/17/12 | M. Kujik | Added Return-Loss measurement |
| 0v1 | 1/6/12 | B. Devuyt | New document |

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APPENDIX B: TYPICAL RETURN-LOSS MEASUREMENT

All measurements at VCC = 3.3V, Temp = +25°C, data pattern = prbs15 (including 20 μs of each polarity of pathological pattern), measured with Belden 1694A cable.

FIGURE B-1: TYPICAL RETURN-LOSS MEASUREMENT (DB VS MHZ)



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Customers should contact their distributor, representative or field application engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: <http://microchip.com/support>

EQCO30T5.2

PRODUCT IDENTIFICATION SYSTEM

To order parts, including industrial, or obtain information, for e.g., on pricing or delivery, refer to the factory or the listed sales office.

| <u>PART NO.</u> | <u>I</u> | <u>RM</u> | <u>XXX</u> |
|----------------------|---|--------------|--------------------------|
| Device | Temp. Range | Radio Module | Firmware Revision Number |
| Device: EQCO30T5.2 | | | |
| Temperature Range: I | = -40°C to +85°C (Industrial temperature) | | |
| Package: TRAY | = Tray | | |
| (Blank) | = Tube | | |

Examples:

- a) EQCO30T5.2 = Industrial temperature, 16-Lead QFN Tube packaging
- b) EQCO30T5.2-TRAY = Industrial temperature, 16-Lead QFN Tray packaging

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